

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Michiaki HIYOSHI

SERIAL NO: New Divisional Application

GAU: Unassigned

FILED: Herewith

EXAMINER: Unassigned

FOR: HERMETICALLY SEALED SEMICONDUCTOR POWER MODULE AND LARGE SCALE MODULE  
COMPRISING THE SAME

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☒ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. The listed references were cited during the prosecution of parent application serial number 09/917,876 filed on July 31, 2001.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☐ Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

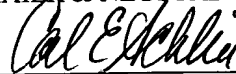
- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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Form PTO 1449  
(Modified)U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICE

ATTY DOCKET NO.

248983US2DIV

SERIAL NO.

New Div Application

## LIST OF REFERENCES CITED BY APPLICANT

APPLICANT

Michiaki HIYOSHI

FILING DATE

Herewith

GROUP

Unassigned

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	4,788,626	11/1988	Amo Neidig et al.			
	AB	5,168,344	12/1992	Ehlert et al.			
	AC	5,942,796	08/1999	Mosser et al.			
	AD	5,446,314	08/1995	Melnick et al.			
	AE	5,750,926	05/1998	Schulman et al.			
	AF	5,945,735	08/1999	Economikos et al.			
	AG	6,078,501	06/2000	Catrambone et al.			
	AH	5,248,901	08/1993	Temple			
	AI	3,303,265	02/1967	Noren et al.			
	AJ	5,297,001	03/1994	Sterling			
	AK	5,532,513	07/1996	Smith et al.			
	AL	5,689,089	11/1997	Polak et al.			
	AM	6,297,549	10/2001	Michiaki Hiyoshi			
	AN	6,303,974	10/2001	Irons et al.			
	AO	3,996,603	12/1976	John Marvin Smith			

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION	
					YES	NO
	AP	3-76578	12/1991	Japan (w/ English Abstract)		X
	AQ	05-121577	05/1993	Japan (w/ English Abstract)		X
	AR	61-284943	11/1986	Japan (w/ English Abstract)		X
	AS					
	AT					
	AU					
	AV					
	AW					

## OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)

	AX	
	AY	
	AZ	
	BA	<input type="checkbox"/> Additional References sheet(s) attached

Examiner

Date Considered

\*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.